

Component mounting apparatus

Publication number: CN1897807 (A)

Publication date: 2007-01-17

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Classification:

- **international:** B23P21/00; H05K13/04; H05K3/30; H05K13/00; B23P21/00; H05K13/04; H05K3/30; H05K13/00

- **European:** H05K13/04E; H05K13/04A4

Application number: CN20061101856 19961106

Priority number(s): JP19950286969 19951106

Also published as:

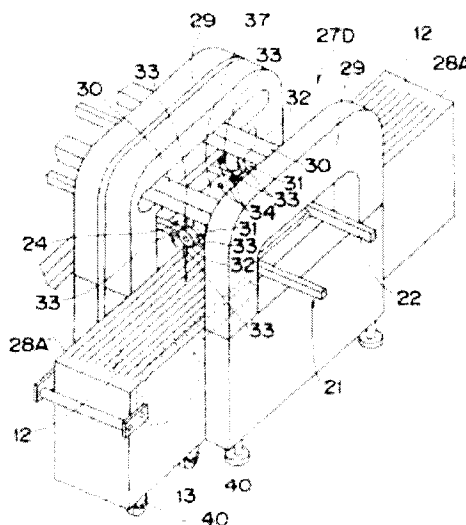
CN100521904 (C)
US5778525 (A)
US2006200975 (A1)
US7356919 (B2)
SG71685 (A1)

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Abstract not available for CN 1897807 (A)

Abstract of corresponding document: **US 5778525 (A)**

There is provided a plurality of component mounting apparatuses for sucking a plurality of components by a mounting head section and successively mounting the components onto a board located at a board positioning section. The component mounting apparatuses are arranged in parallel to one another, and a board transfer path is provided so that it penetrates the component mounting apparatuses. Even when the number of components to be mounted onto the board increases, the components are mounted on the component supply tables of the component mounting apparatuses as distributed thereto, and therefore, the whole apparatus is not dimensionally increased. The component supply tables are fixedly installed so as to become free of vibration, and the mounting head section executes the suction and the mounting of the plurality of components. Therefore, the component mounting operation speed can be remarkably increased.



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